

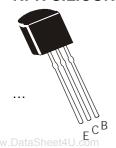


CSC1047



An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company

NPN SILICON PLANAR EPITAXIAL TRANSISTOR



TO-92 Plastic Package

Suitable for RF Amplifier in FM/AM Radios

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Base Voltage	V_{CBO}	30	V
Collector Emitter Voltage	V_{CEO}	20	V
Emitter Base Voltage	V_{EBO}	3	V
Collector Current	I _C	15	mA
Power Dissipation @ T _a =25°C	P _C	*400	mW
Junction Temperature	Tj	150	оС
Storage Temperature Range	T_{stg}	- 55 to +150	°C

^{*}P_C=250mW / Potting type: P_C=250mW

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

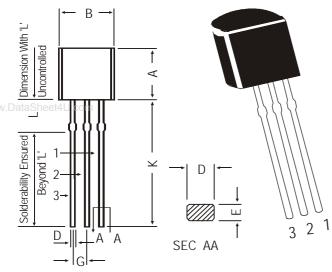
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Base Voltage	V_{CBO}	$I_C = 10\mu A, I_E = 0$	30			V
Emitter Base Voltage	V_{EBO}	$I_E = 10\mu A, I_C = 0$	3			V
DC Current Gain	*h _{FE}	$V_{CE} = 6V, -I_{C} = 1mA$	40		260	
Transition Frequency	f _T	$V_{CE} = 6V, -I_{C} = 1mA$	450			MHz
Base Emitter On Voltage	$V_{BE(on)}$	$V_{CE} = 6V, -I_{C} = 1mA$		0.72		V
Common Emitter Reverse- Transfer Capacitance	C_{re}	$V_{CB} = 6V$, - $I_E = 1mA$, $f=10.7MHz$			1	pF
Power Gain	PG	$V_{CB} = 6V$, - $I_{E} = 1mA$, $f = 100 MHz$	20			dB
Noise Figure	NF	$V_{CB} = 6V$, - $I_E = 1$ mA, f=100 MHz			5	dB

*h_{FE} Classifications B : 40 - 110 C : 65 - 160 D : 100 - 260

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TO-92 Transistors on Tape and Ammo Pack



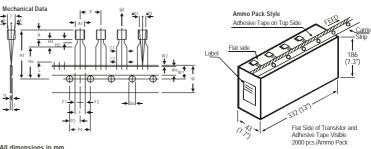
F	<u></u>
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PIN CONFIGURATION

- 1. BASE
- 2. COLLECTOR
- 3. EMITTER

DIM	MIN.	MAX.				
Α	4.32	5.33				
В	4.45	5.20				
С	3.18	4.19				
D	0.41	0.55				
Е	0.35	0.50				
F	5 D	EG				
G	1.14	1.40				
Н	1.14	1.53				
K	12.70	_				
L	1.982	2.082				
All Parts of a second						

All diminsions in mm.



AII	dimensions	s in	mr

		SPECIFICATION			ION	
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	REMARKS
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	A	4.8		5.2		
BODY THICKNESS	T	3.9		4.2		
PITCH OF COMPONENT	P		12.7		± 1.0	
FEED HOLE PITCH	Po		12.7		± 0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
FEED HOLE CENTRE TO						
COMPONENT CENTRE	P2		6.35		± 0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER						
LEADS	F		5.08		+ 0.6 - 0.2	
COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0	- 0.2	AT TOP OF BODY
COMPONENT ALIGNMENT FRONT VIEW	_		0	1.3		AT TOP OF BODY
TAPE WIDTH	W		18		± 0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	
HOLE POSITION	W1		9		+ 0.7	
					- 0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2	
LEAD WIRE CLINCH HEIGHT	Ho		16		± 0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	
TOTAL TAPE THICKNESS	t			1.2		t1 0.3-0.6
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4	
STAND OFF	H2	0.45		1.45	- 0.1	
CLINCH HEIGHT	H3	0.43		3.0		
LEAD PARALLELISM	C1 - C2			0.22		
PULL - OUT FORCE	(P)	6N		0.22		

- NOTES

 1. Maximum alignment deviation between leads will not to be greater than 0.2mm.

 2. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.

 3. Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.

 4. There will be no more than three (3) consecutive missing components in a tape.

 5. A tape trailer, having at least three feed holes are provided after the last component in a tape.

 6. Splices should not interfere with the sprocket feed holes.

Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details Net Weight / Oty		Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

Notes CSC1047

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Disclaimer

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